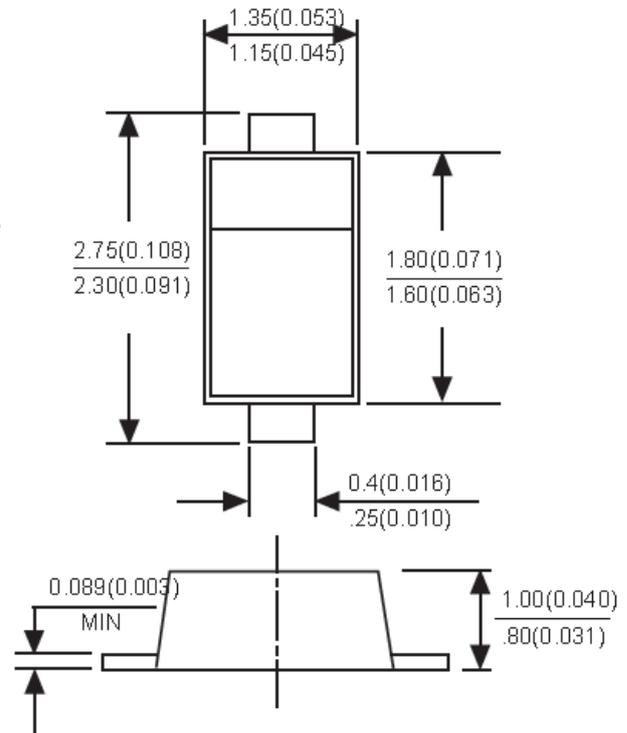


Technical Data
Data Sheet N0572, Rev. A
Features

- High Conductance
- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automatic Insertion
- For General Purpose Switching Application
- Plastic Material – UL Recognition Flammability Classification 94V-0
- Green Products in Compliance with the RoHS Directive
- This is a Pb - Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Mechanical Data

- Case: SOD-323, Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Weight: 0.004 grams (approx.)
- Marking: T4



Dimensions in millimeters and (inches)

Maximum Ratings @T_A=25°C unless otherwise specified

Characteristic	Symbol	1N4148WS	Unit	
Non-Repetitive Peak Reverse Voltage	V _{RM}	100	V	
Peak Repetitive Reverse Voltage	V _{RRM}	75	V	
Working Peak Reverse Voltage	V _{RWM}			
DC Blocking Voltage	V _R			
RMS Reverse Voltage	V _{R(RMS)}	53	V	
Forward Continuous Current (Note 1)	I _{FM}	300	mA	
Average Rectified Output Current (Note 1)	I _O	150	mA	
Non-Repetitive Peak Forward Surge Current	I _{FSM}	@ t = 1.0µs	2.0	A
		@ t = 1.0s	1.0	
Power Dissipation (Note 1)	P _d	200	mW	
Typical Thermal Resistance, Junction to Ambient Air (Note 1)	R _{θJA}	625	K/W	
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C	

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Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	1N4148WS	Unit
Forward Voltage Drop @ $I_F = 10\text{mA}$	V_{FM}	1.0	V
Peak Reverse Leakage Current @ $V_R = 75\text{V}$	I_{RM}	2.5	μA
Junction Capacitance ($V_R = 0\text{V DC}$, $f = 1.0\text{MHz}$)	C_j	2.0	pF
Reverse Recovery Time (Note 2)	t_{rr}	4.0	nS

Note: 1. Valid provided that terminals are kept at ambient temperature.
2. Measured with $I_F = I_R = 10\text{mA}$, $I_{RR} = 0.1 \times I_R$, $R_L = 100\ \Omega$.

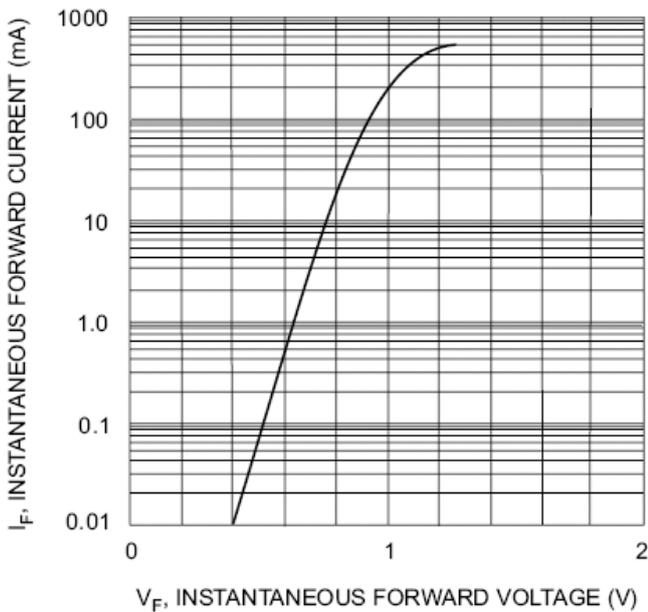


Fig. 1 Forward Characteristics

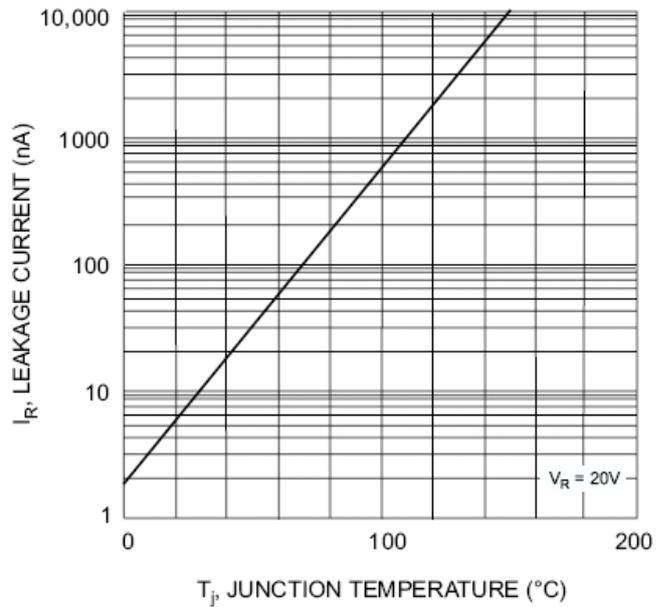


Fig. 2 Leakage Current vs Junction Temperature



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